AUIRFP4409

S

Features

- Advanced Process Technology
- Low On-Resistance

International

IOR Rectifier

- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Timax
- Lead-Free, RoHS Compliant
- Automotive Qualified *

Description

Specifically designed for Automotive applications, this HEXFET[®] Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.





Ordering Information

Base part number	Dookogo Tupo	Standard Pack		Complete Part Number
	Package Type	Form	Quantity	
AUIRFP4409	TO-247AC	Tube	25	AUIRFP4409

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (TA) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	38	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	27	А
I _{DM}	Pulsed Drain Current ①	152	
P _D @T _C = 25°C	Maximum Power Dissipation	341	W
	Linear Derating Factor	2.3	W/°C
V _{GS}	Gate-to-Source Voltage	± 20	V
EAS (Thermally limited)	Single Pulse Avalanche Energy ②	541	mJ
Tj T _{STG}	Operating Junction and Storage Temperature Range	-55 to + 175	°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	
	Mounting Torque, 6-32 or M3 Screw	10 lbf·in (1.1 N·m)	

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{ ext{ heta}JC}$	Junction-to-Case ®		0.44	
$R_{ ext{ heta}CS}$	Case-to-Sink, Flat Greased Surface	0.24		°C/W
$R_{ heta JA}$	Junction-to-Ambient Ø		40	

HEXFET® is a registered trademark of International Rectifier. *Qualification standards can be found at http://www.irf.com/

Static @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	300			V	V _{GS} = 0V, I _D = 250µA
$\Delta V_{(BR)DSS} / \Delta T_J$	Breakdown Voltage Temp. Coefficient		0.24		V/°C	Reference to 25° C, I _D = 3.5mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		56	69	mΩ	V _{GS} = 10V, I _D = 24A ④
V _{GS(th)}	Gate Threshold Voltage	3.0		5.0	V	V_{DS} = V_{GS} , I_D = 250 μ A
				20		V _{DS} =300 V, V _{GS} = 0V
IDSS	Drain-to-Source Leakage Current			250	μA	V _{DS} =300V,V _{GS} = 0V,T _J =125°C
	Gate-to-Source Forward Leakage			100	م ۸	V _{GS} = 20V
I _{GSS}	Gate-to-Source Reverse Leakage			-100	nA	V _{GS} = -20V
R _G	Gate Resistance		1.3		Ω	

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

gfs	Forward Transconductance	45			S	V _{DS} = 50V, I _D =24A
Qg	Total Gate Charge		83	125		I _D = 24A
Q _{gs}	Gate-to-Source Charge		28	42	nC	V _{DS} = 150V
Q_{gd}	Gate-to-Drain Charge		26	39		V _{GS} = 10V
t _{d(on)}	Turn-On Delay Time		18			V _{DD} = 195V
t _r	Rise Time		23			I _D = 24A
t _{d(off)}	Turn-Off Delay Time		34		ns	R _G = 2.2Ω
t _f	Fall Time		20			V _{GS} = 10V
C _{iss}	Input Capacitance		5168			V _{GS} = 0V
C _{oss}	Output Capacitance		300			V _{DS} = 50V
C _{rss}	Reverse Transfer Capacitance		77		рF	f = 1.0MHz
$C_{\text{oss eff.}(\text{ER})}$	Effective Output Capacitance (Energy Related)		196		P'	V _{GS} = 0V, VDS = 0V to 240V⑥ See Fig.11
Coss eff.(TR)	Output Capacitance (Time Related)		265			$V_{GS} = 0V, VDS = 0V \text{ to } 240V$

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current (Body Diode)①			40		MOSFET symbol showing the
I _{SM}	Pulsed Source Current (Body Diode) ①			160		integral reverse <u>and service</u> s p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_{J} = 25^{\circ}C, I_{S} = 24A, V_{GS} = 0V @$
t _{rr}	Reverse Recovery Time		302		ns	<u>T_J = 25°C</u> V _{DD} = 255V
۲r			379		115	<u>T」= 125°C</u> I _F = 24A,
0	Deverse Resevery Charge		1739			<u>T_J = 25°C</u> di/dt = 100A/µs ④
Q _{rr}	Reverse Recovery Charge		2497		nC	<u>T」= 125°C</u>
I _{RRM}	Reverse Recovery Current		13		Α	T _J = 25°C

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- @ Recommended max EAS limit, starting T_J = 25°C, L = 2.05mH, R_G = 50 Ω , I_{AS} = 24A, V_{GS} =10V.
- $I_{SD} \leq 24A$, di/dt $\leq 1771A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq 175^{\circ}C$.
- ④ Pulse width \leq 400µs; duty cycle \leq 2%.
- S Coss eff. (TR) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 to 80% VDSS.
- 6 Coss eff. (ER) is a fixed capacitance that gives the same energy as Coss while VDS is rising from 0 to 80% VDSS.
- ② When mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques
- refer to application note #AN-994 http://www.irf.com/technical-info/ app notes/an-994.pdf
- $\label{eq:rescaled} \$ \ \ \mathsf{R} \theta \text{ is measured at } \mathsf{T}_\mathsf{J} \text{ approximately } 90^\circ\mathsf{C}$



Qualification Information[†]

			Automotive (per AEC-Q101)				
Qualification	Level	Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.					
Moisture Sensitivity Level		TO-247AC	N/A				
	Machine Model	Class M4 (+/- 500V) ^{††}					
		AEC-Q101-002					
	Human Body Model	Class H2 (+/- 4000V) ^{††}					
ESD		AEC-Q101-001					
	Charged Device Model	Class C5 (+/- 2000) ^{††}					
			AEC-Q101-005				
RoHS Compliant		Yes					

† Qualification standards can be found at International Rectifier's web site: <u>http://www.irf.com/</u>

†† Highest passing voltage.





Fig 1. Typical Output Characteristics





Fig 5. Typical Capacitance vs. Drain-to-Source Voltage







Fig 4. Normalized On-Resistance vs. Temperature



Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage



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Fig 11. Typical Coss Stored Energy







Fig 10. Drain-to-Source Breakdown Voltage



Fig 12. Threshold Voltage vs. Temperature





Fig 13. Maximum Effective Transient Thermal Impedance, Junction-to-Case







Fig 16. Typical Stored Charge vs. dif/dt



Fig 15. Typical Recovery Current vs. dif/dt







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Fig 18. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET[®] Power MOSFETs



Fig 19a. Unclamped Inductive Test Circuit







Fig 21a. Gate Charge Test Circuit



Fig 19b. Unclamped Inductive Waveforms



Fig 20b. Switching Time Waveforms



Fig 21b. Gate Charge Waveform



TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



DIMENSIONS SYMBOL INCHES **MILLIMETERS** NOTES MAX. MIN. MAX MIN .190 .204 4.83 5.20 A1 .090 100 2.29 2.54 .075 .085 1.91 2.16 A2 .042 .052 1.07 1.33 b .075 .094 1.91 2.41 b2 b4 .113 .133 2.87 3.38 .022 026 0.55 0.68 .819 .830 20.80 21.10 D D1 .640 694 16.25 17.65 5 .620 .635 15.75 16.13 4 F F1 512 570 13.00 14 50 E2 .145 .196 3.68 5.00 ypical 215 5 45 *r*oical е 1 .780 .800 19.80 20.32 11 161 173 4 10 4,40 øΡ .138 .143 3.51 3.65 0 216 2.36 5 4 9 6.00 S .238 .248 6.04 6.30

LEAD	ASSIGN	MEN	ITS

<u>HEXFET</u>

- 1.– GATE 2.– DRAIN 3.– SOURCE
- 4.- DRAIN

IGBTs, CoPACK

- 1.– GATE 2.– COLLECTOR 3.– EMITTER
- 4.- COLLECTOR

<u>DIODES</u>

1.- ANODE/OPEN 2.- CATHODE

3.- ANODE

NOTES:

1 DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M 1994.

2 DIMENSIONS ARE SHOWN IN INCHES AND MILLIMETERS.

- CONTOUR OF SLOT OPTIONAL.
- \triangle dimension d & e do not include Mold Flash. Mold Flash shall not exceed .005" (0.127) per side. These dimensions are measured at the outermost extremes of the plastic body.
- THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS D1 & E1.

6 LEAD FINISH UNCONTROLLED IN L1.

TO-247AC Part Marking Information

(⊕|Ø.010@|B|A@) MEW. "A" - "A" (c)

SECTION: C-C, D-D, E-E



TO-247AC package is not recommended for Surface Mount Application.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



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For technical support, please contact IR's Technical Assistance Center

http://www.irf.com/technical-info/

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